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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.
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09/100,838	06/19/98	MURARI	B 851063.425
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EXAMINER

KWOK, H

ART UNIT

PAPER NUMBER

2856

DATE MAILED:

07/19/00

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

Office Action Summary

Application No.
09/100,838

Applicant(s)

Murari et al.

Examiner

H. Kwok

Group Art Unit
2856



☒ Responsive to communication(s) filed on May 1, 2000

☐ This action is **FINAL**.

☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11; 453 O.G. 213.

A shortened statutory period for response to this action is set to expire 3 month(s), or thirty days, whichever is longer, from the mailing date of this communication. Failure to respond within the period for response will cause the application to become abandoned. (35 U.S.C. § 133). Extensions of time may be obtained under the provisions of 37 CFR 1.136(a).

Disposition of Claims

☒ Claim(s) 1-20 is/are pending in the application.

Of the above, claim(s) 8-11 is/are withdrawn from consideration.

☐ Claim(s) _____ is/are allowed.

☒ Claim(s) 1-7 and 12-20 is/are rejected.

☐ Claim(s) _____ is/are objected to.

☐ Claims _____ are subject to restriction or election requirement.

Application Papers

☐ See the attached Notice of Draftsperson's Patent Drawing Review, PTO-948.

☐ The drawing(s) filed on _____ is/are objected to by the Examiner.

☐ The proposed drawing correction, filed on _____ is ☐ approved ☐ disapproved.

☐ The specification is objected to by the Examiner.

☐ The oath or declaration is objected to by the Examiner.

Priority under 35 U.S.C. § 119

☐ Acknowledgement is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d).

☐ All ☐ Some* ☐ None of the CERTIFIED copies of the priority documents have been
☐ received.

☐ received in Application No. (Series Code/Serial Number) _____.

☐ received in this national stage application from the International Bureau (PCT Rule 17.2(a)).

*Certified copies not received: _____

☐ Acknowledgement is made of a claim for domestic priority under 35 U.S.C. § 119(e).

Attachment(s)

☒ Notice of References Cited, PTO-892

☐ Information Disclosure Statement(s), PTO-1449, Paper No(s). _____

☐ Interview Summary, PTO-413

☐ Notice of Draftsperson's Patent Drawing Review, PTO-948

☐ Notice of Informal Patent Application, PTO-152

--- SEE OFFICE ACTION ON THE FOLLOWING PAGES ---

Art Unit: 2856

DETAILED ACTION

Claim Rejections - 35 U.S.C. § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless --

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

2. Claims 1-7 and 12-20 are rejected under 35 U.S.C. 102(b) as being anticipated by WO 96/39632 (Martin et al.).

With regards to claims 1-7, Martin et al. discloses a package for sealing an integrated circuit die comprising, as illustrated in Figures 2 and 4, a first chip of semiconductor material 10; a sensing element 24 formed on the chip; a hollow structure 36 enclosing the sensing element; a metal wall 30 disposed on the chip; and a closure plate 32 made of metal or polymeric material is fixed to the metal wall; a processing circuit for processing electrical signals formed on a second semiconductor chip and in electrical connection with the sensitive element by ballbonds 16 and wirebonds 18. Furthermore, a plastic container encapsulating the chip, sensing element and hollow structure. (See, pages 4-9).

With regards to claims 12-20, the claims are commensurate in scope with claims 1-7 and are rejected for the same reasons as set forth above.

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3. Claims 1-7 and 12-20 are rejected under 35 U.S.C. 102(b) as being anticipated by U.S. Patent 5,438,859 (Yamashita et al.).

With regards to claims 1-7, Yamashita et al. discloses an acceleration sensor comprising, as illustrated in Figures 17-21, a chip of semiconductor material 82 (i.e. a hybrid integrated chip); a sensing element 81 formed on a surface of the chip; a hollow structure (the interior space formed by cover body 87 formed over the semiconductor chip) enclosing the sensing element; a processing circuit 84 and other various circuitries are formed in a second semiconductor chip to receive signals in response to the sensor element by conductive pads (i.e. electrodes) 54a-54f as observed in Figures 12-13. (See, column 15, line 45 to column 16, line 17; column 16, lines 55-59).

With regards to claims 12-20, these claims are commensurate in scope with claims 1-7 and are rejected for the same reasons as set forth above.

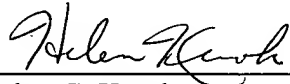
Response to Amendment

4. Applicant's arguments with respect to claims 1-7 and 12-20 have been considered but are moot in view of the new ground(s) of rejection.

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Conclusion

5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Helen Kwok whose telephone number is (703) 308-8149.


Helen C. Kwok
Art Unit 2856

hck
July 17, 2000